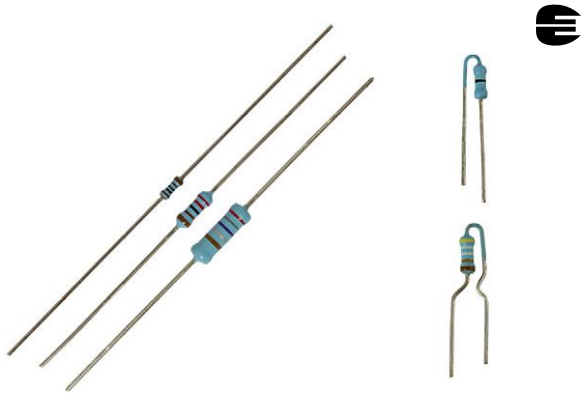
Precision Metal Film Leaded Resistors



FEATURES

- IECQ-CECC approved according to EN 140101-806
- Superior overall stability: class 0.05
- Wide precision ohmic range: 10 Ω to 1.5 MΩ
- Radial version available for MBB/SMA 0207
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Pb-free
RoHS COMPLIANT
HALOGEN FREE

APPLICATIONS

- Test and measuring equipment
- Industrial electronics
- Medical electronics

LINKS TO ADDITIONAL RESOURCES

3D Models

DESCRIPTION

MBA/SMA 0204, MBB/SMA 0207, and MBE/SMA 0414 precision leaded thin film resistors combine the proven reliability of the professional products with an advanced level of precision and stability. Therefore they are perfectly suited for applications in the fields of test and measuring equipment along with industrial and medical electronics.

TECHNICAL SPECIFICATIONS

DESCRIPTION	MBA/SMA 0204	MBB/SMA 0207	MBE/SMA 0414
DIN size	0204	0207	0414
CECC size	A	B	D
Resistance range	22 Ω to 332 kΩ	10 Ω to 1 MΩ	22 Ω to 1.5 MΩ
Resistance tolerance	± 0.25 %; ± 0.1 %		
Temperature coefficient	± 25 ppm/K; ± 15 ppm/K		
Rated dissipation, P_{70}	0.25 W	0.40 W	0.65 W
Operating voltage, $U_{max.}$ AC_{RMS}/DC	200 V	350 V	500 V
Operating temperature range (1)	-55 °C to +125 °C		
Permissible film temperature, $\vartheta_{F\ max.}$ (1)	125 °C		
Permissible voltage against ambient (insulation):			
1 min; U_{ins}	300 V	500 V	800 V
Continuous	75 V	75 V	75 V
Failure rate: $FIT_{observed}$	≤ 0.1 x 10^{-9}/h		

Notes

- MB_ series has been merged with the related SMA series to form one series “MB_/SMA__”

(1) Please refer to APPLICATION INFORMATION below

For technical questions, contact: filmresistorsleaded@vishay.com

APPLICATION INFORMATION

The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature is not exceeded. Furthermore, a high level of ambient temperature or of power dissipation may raise the temperature of the solder joint, hence special solder alloys or board materials may be required to maintain the reliability of the assembly.

These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime. The designer may estimate the performance of the particular resistor application or set certain load and temperature limits in order to maintain a desired stability.

MAXIMUM RESISTANCE CHANGE AT RATED DISSIPATION				
Operation mode			Precision	Standard
Climatic category			-10 °C / +85 °C / 56 days	-55 °C / +125 °C / 56 days
Rated dissipation, P_{70}		**MBA/SMA 0204**	0.07 W	0.25 W
		MBB/SMA 0207	0.11 W	0.40 W
		MBE/SMA 0414	0.17 W	0.65 W
Permissible film temperature, $\vartheta_{F\ max.}$			85 °C	125 °C
Max. resistance change at rated dissipation $\lvert\Delta R/R$ max.$\rvert$, after:		**MBA/SMA 0204**	100 Ω to 100 kΩ	100 Ω to 100 kΩ
		1000 h	≤ 0.05 %	≤ 0.25 %
		8000 h	≤ 0.1 %	≤ 0.5 %
		225 000 h	≤ 0.3 %	≤ 1.5 %
		MBB/SMA 0207	100 Ω to 270 kΩ	100 Ω to 270 kΩ
		1000 h	≤ 0.03 %	≤ 0.15 %
		8000 h	≤ 0.1 %	≤ 0.5 %
		225 000 h	≤ 0.3 %	≤ 1.5 %
		MBE/SMA 0414	100 Ω to 470 kΩ	100 Ω to 470 kΩ
		1000 h	≤ 0.05 %	≤ 0.2 %
		8000 h	≤ 0.1 %	≤ 0.4 %
		225 000 h	≤ 0.3 %	≤ 1.2 %

Note

- The presented operation modes do not refer to different types of resistors, but actually show examples of different loads, that lead to different film temperatures and different achievable load-life stability (drift) of the resistance value. A suitable low thermal resistance of the circuit board assembly must be safeguarded in order to maintain the film temperature of the resistors within the specified limits

TEMPERATURE COEFFICIENT AND RESISTANCE RANGE (1)				
TYPE / SIZE	**TCR**	**TOLERANCE**	**RESISTANCE (2)**	**E-SERIES**
MBA/SMA 0204	± 25 ppm/K	± 0.25 %	22 Ω to 332 kΩ	E96; E192
		± 0.1 %	43 Ω to 332 kΩ	
	± 15 ppm/K	± 0.25 %	22 Ω to 221 kΩ	
		± 0.1 %	43 Ω to 221 kΩ	
MBB/SMA 0207	± 25 ppm/K	± 0.25 %	10 Ω to 1 MΩ	
		± 0.1 %	10 Ω to 1 MΩ	
	± 15 ppm/K	± 0.25 %	10 Ω to 1 MΩ	
		± 0.1 %	10 Ω to 1 MΩ	
MBE/SMA 0414	± 25 ppm/K	± 0.25 %	22 Ω to 1.5 MΩ	
		± 0.1 %	43 Ω to 1 MΩ	
	± 15 ppm/K	± 0.25 %	22 Ω to 1 MΩ	
		± 0.1 %	43 Ω to 1 MΩ	

Notes

- Radial version (RB, UB) cannot be qualified according to CECC so these can only be ordered with variant N or S

(1) Approval is according to EN 140101-806, version A, or the approved IECQ-CECC resistance range, please refer to: www.vishay.com/doc?28945

PACKAGING

TYPE / SIZE	CODE	QUANTITY	PACKAGING STYLE	WIDTH	PITCH	PACKAGING DIMENSIONS
MBA/SMA 0204	C1	1000	Taped acc. to IEC 60286-1 fan-folded in a box	53 mm	5 mm	184 mm x 75 mm x 42 mm
	CT	5000				330 mm x 75 mm x 55 mm
MBB/SMA 0207	C1	1000	Taped acc. to IEC 60286-1 fan-folded in a box	53 mm	5 mm	184 mm x 74 mm x 42 mm
	CT	5000				324 mm x 77 mm x 82 mm
MBB/SMA 0207 UB = 2.5 mm pitch	N4	4000	Taped acc. to IEC 60286-2 fan-folded in a box	-	12.7 mm	330 mm x 262 mm x 45 mm
	R4	4000	Taped acc. to IEC 60286-2 on a reel	-		330 mm x 253 mm x 48 mm
MBB/SMA 0207 RB = 5.0 mm pitch	N4	4000	Taped acc. to IEC 60286-2 fan-folded in a box	-		330 mm x 262 mm x 45 mm
	R4	4000	Taped acc. to IEC 60286-2 on a reel	-		330 mm x 253 mm x 48 mm
MBE/SMA 0414	C1	1000	Taped acc. to IEC 60286-1 fan-folded in a box	63 mm	5 mm	374 mm x 84 mm x 47 mm

Note

- For details related to packaging specs, refer datasheet link www.vishay.com/doc?28721

PART NUMBER AND PRODUCT DESCRIPTION - CECC APPROVED PRODUCTS

Part Number: MBB0207VD1001BCT00

M	B	B	0	2	0	7	V	D	1	0	0	1	B	C	T	0	0

TYPE / SIZE	VERSION	TCR	RESISTANCE	TOLERANCE	PACKAGING	SPECIAL
MBA0204 = MBA/SMA 0204 **MBB0207** = MBB/SMA 0207 **MBE0414** = MBE/SMA 0414	**V** = CECC 06 **N** = RB radial 5 mm for MBB/SMA 0207 **S** = UB radial 2.5 mm for MBB/SMA 0207	**E** = ± 15 ppm/K **D** = ± 25 ppm/K	**3 digit value** **1 digit multiplier** MULTIPLIER **9** = $*10^{-1}$ **2** = $*10^{2}$ **0** = $*10^{0}$ **3** = $*10^{3}$ **1** = $*10^{1}$ **4** = $*10^{4}$	**B** = ± 0.1 % **C** = ± 0.25 %	**CT** **C1** **N4** **R4**	**00** = standard **L0** = welding joint not lacquered for MBB/SMA 0207 **KL** = lacquered welding joint for MBA/SMA 0204

Product Description: MBB/SMA 0207-25 0.1 % CECC 06 CT 1K0

MBB/SMA 0207	-	25	0.1 %	CECC 06	CT	1K0
TYPE / SIZE		TCR	TOLERANCE	VERSION	PACKAGING	RESISTANCE
MBA/SMA 0204 **MBB/SMA 0207** **MBE/SMA 0414**		± **15** ppm/K ± **25** ppm/K	± **0.1** % ± **0.25** %	**CECC 06** **CECC 06 L0** **CECC 06 KL**	**CT** **C1** **N4** **R4**	**1K0** = 1 kΩ **51R1** = 51.1 Ω

Note

- The products can be ordered using either the PRODUCT DESCRIPTION or the PART NUMBER

DESCRIPTION

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A homogeneous film of metal alloy is deposited on a high grade ceramic body and conditioned to achieve the desired temperature coefficient. Plated steel termination caps are firmly pressed on the metallized rods. A special laser is used to achieve the target value by smoothly cutting a helical groove in the resistive layer without damaging the ceramics. Connecting wires of electrolytic copper plated with 100 % pure matte tin are welded to the termination caps. The resistor elements are covered by a light blue protective coating designed for electrical, mechanical and climatic protection. Four or five color code rings designate the resistance value and tolerance in accordance with **IEC 60062**.

The result of the determined production is verified by an extensive testing procedure performed on 100 % of the individual resistors. Only accepted products are stuck directly on the adhesive tapes in accordance with **IEC 60286-1** or for the radial versions in accordance with **IEC 60286-2**.

MATERIALS

Vishay acknowledges the following systems for the regulation of hazardous substances:

- IEC 62474, Material Declaration for Products of and for the Electrotechnical Industry, with the list of declarable substances given therein (1)
- The Global Automotive Declarable Substance List (GADSL) (2)
- The REACH regulation (1907/2006/EC) and the related list of substances with very high concern (SVHC) (3) for its supply chain

The products do not contain any of the banned substances as per IEC 62474, GADSL, or the SVHC list, see www.vishay.com/how/leadfree.

Hence the products fully comply with the following directives:

- 2000/53/EC End-of-Life Vehicle Directive (ELV) and Annex II (ELV II)
- 2011/65/EU Restriction of the Use of Hazardous Substances Directive (RoHS) with amendment 2015/863/EU
- 2012/19/EU Waste Electrical and Electronic Equipment Directive (WEEE)

Vishay pursues the elimination of conflict minerals from its supply chain, see the Conflict Minerals Policy at www.vishay.com/doc?49037.

ASSEMBLY

The resistors are suitable for processing on automatic insertion equipment and cutting and bending machines. Excellent solderability is proven, even after extended storage. They are suitable for automatic soldering using wave or dipping.

The resistors are completely lead (Pb)-free, the pure matte tin plating provides compatibility with lead (Pb)-free and lead-containing soldering processes. The immunity of the plating against tin whisker growth, in compliance with **IEC 60068-2-82**, has been proven under extensive testing.

The encapsulant is resistant to cleaning solvent specified in **IEC 60115-1** (3). The suitability of conformal coatings, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system.

All products comply with **GADSL** (1) and the **IEC 62474** (2) list of legal restrictions on hazardous substances. This includes full compliance with the following directives:

- 2000/53/EC End of Vehicle Life Directive (ELV) and Annex II (ELVII)
- 2011/65/EU Restriction of the use of Hazardous Substances Directive (RoHS)
- 2002/96/EC Waste Electrical and Electrical Equipment Directive (WEEE)

APPROVALS

The resistors (CECC version) are approved within the IECQ-CECC Quality Assessment System for Electronic Components to the detail specification **EN 140101-806** which refers to **EN 60115-1** and **EN 60115-2** and the variety of environmental test procedures of the **IEC 60068** series. Conformity is attested by the use of the CECC logo () as the Mark of Conformity on the package label for the CECC version.

Vishay Beyschlag has achieved "**Approval of Manufacturer**" in accordance with **IECQ 03-3-1, clause 2**. The release certificate for "**Technology Approval Schedule**" in accordance with **CECC 240001** based on **IECQ 03-3-1, clause 6** is granted for the Vishay Beyschlag manufacturing process.

RELATED PRODUCTS

For a corelated range of professional TCR and tolerance specifications see the datasheet:

- "Professional Thin Film Leaded Resistors", www.vishay.com/doc?28766

For products approved to **EN 140101-806**, version E, with established reliability and failure rate level E7 (Quality factor $\pi Q = 0.1$), see the datasheet:

- "Established Reliability Thin Film Leaded Resistors", www.vishay.com/doc?28768

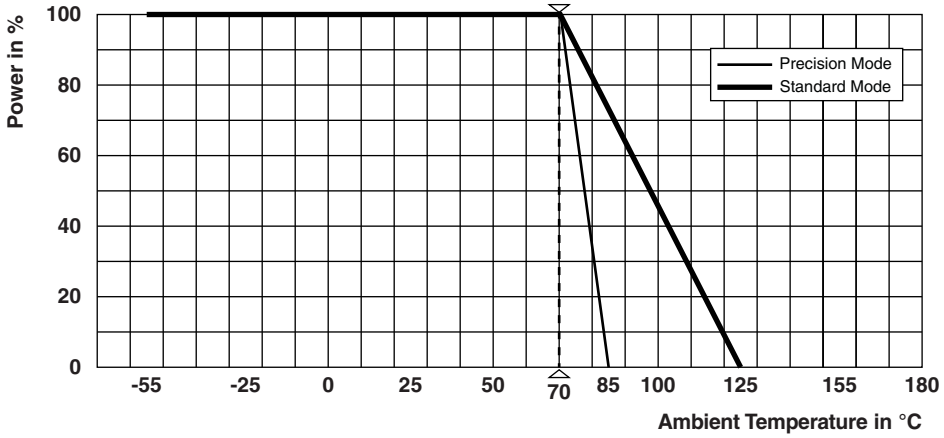
Notes

(1) Global Automotive Declarable Substance List, see www.gadsl.org

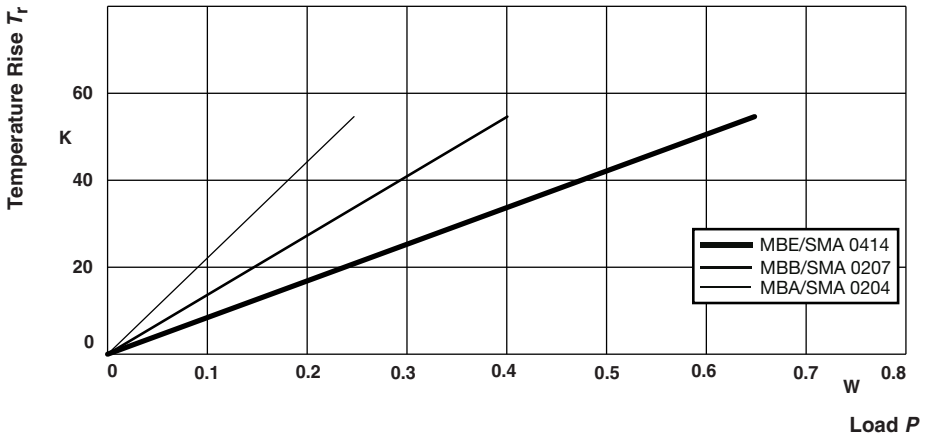
(2) CEFIC (European Chemical Industry Council), EECA (European Electronic Component Manufacturers Association), EICTA (European trade organization representing the information and communications technology and consumer electronics), see www.digitaleurope.org/SearchResults.aspx?Search=eicta.
All products comply with the IEC 62474, Material Declaration for Products of and for the Electrotechnical Industry

(3) Other cleaning solvents with aggressive chemicals should be evaluated in actual cleaning process for their suitability

FUNCTIONAL PERFORMANCE

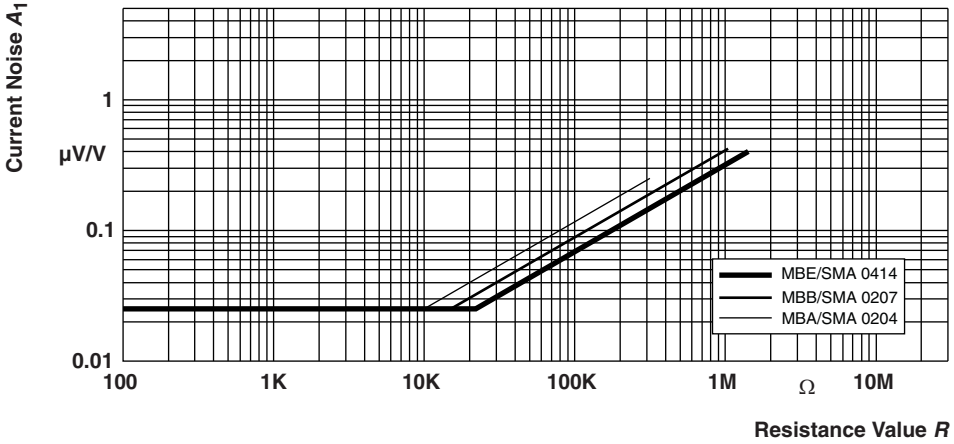


Derating



Rise of the surface temperature.

Temperature Rise



Current Noise A_1 in accordance with IEC 60195

TEST PROCEDURES AND REQUIREMENTS

All tests are carried out in accordance with the following specifications:

- IEC 60115-1, generic specification
- IEC 60115-2, sectional specification
- EN 140101-806, detail specification
- IEC 60068-2-xx, test methods

The components are approved under the IECQ-CECC quality assessment system for electronic components. The parameters stated in the Test Procedures and Requirements table are based on the required tests and permitted limits of EN 140101-806. The table presents only the most important tests, for the full test schedule refer to the documents listed above. However, some additional tests and a number of improvements against those minimum requirements have been included. The testing also covers most of the requirements specified by EIA/ECA-703 and JIS-C-5201-1. The tests are carried out under standard atmospheric conditions in accordance with IEC 60068-1, 4.3, whereupon the following values are applied:

- Temperature: 15 °C to 35 °C
- Relative humidity: 25 % to 75 %
- Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar)

A climatic category LCT / UCT / 56 is applied, defined by the lower category temperature (LCT), the upper category temperature (UCT), and the duration of exposure in the damp heat, steady state test (56 days). The components are mounted for testing on printed circuit boards in accordance with IEC 60115-1, 5.5, unless otherwise specified.

TEST PROCEDURES AND REQUIREMENTS

IEC 60115-1 CLAUSE (3)	IEC 60068-2 TEST METHOD (3)	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR max.)		
			Stability for product types:	STABILITY CLASS 0.05	STABILITY CLASS 0.1	STABILITY CLASS 0.25
			MBA/SMA 0204	100 Ω to 100 kΩ	43 Ω to 221 kΩ	22 Ω to 332 kΩ
			MBB/SMA 0207	100 Ω to 270 kΩ	43 Ω to 510 kΩ	10 Ω to 1 MΩ
			MBE/SMA 0414	100 Ω to 470 kΩ	43 Ω to 1 MΩ	22 Ω to 1.5 MΩ
6.1	-	Resistance	-	± 0.25 %; ± 0.1 %		
12.2	-	Voltage proof	$U_{RMS} = U_{ins}$; 60 s	No flashover or breakdown		
6.2	-	Temperature coefficient	At 20/LCT/20 °C and 20/UCT/20 °C	± 25 ppm/K; ± 15 ppm/K		
8.1	-	Short time overload	Room temperature; $U = 2.5 \times \sqrt{P_{70} \times R}$ or $U = 2 \times U_{max.}$; 5 s	± (0.01 % R + 0.01 Ω) no visible damage	± (0.02 % R + 0.01 Ω) no visible damage	± (0.05 % R + 0.01 Ω) no visible damage
9.5	21 (Ua_1) 21 (Ub) 21 (Uc)	Robustness of terminations	Tensile, bending and torsion	± (0.01 % R + 0.01 Ω)	± (0.02 % R + 0.01 Ω)	± (0.05 % R + 0.01 Ω)
11.1	20 (Ta)	Solderability	+235 °C; 2 s solder bath method; SnPb40 +245 °C; 3 s solder bath method; SnAg3Cu0.5	Good tinning (≥ 95 % covered, no visible damage)		
11.2	20 (Tb)	Resistance to soldering heat	Unmounted components; (270 ± 3) °C; (10 ± 1) s	± (0.01 % R + 0.01 Ω) no visible damage	± (0.02 % R + 0.01 Ω) no visible damage	± (0.05 % R + 0.01 Ω) no visible damage
10.1	14 (Na)	Rapid change of temperature	30 min at LCT = -55 °C 30 min at UCT = 125 °C 5 cycles MBA/SMA 0204: 500 cycles MBB/SMA 0207: 200 cycles MBE/SMA 0414: 100 cycles	± (0.01 % R + 0.01 Ω) no visible damage ± (0.25 % R + 0.05 Ω) no visible damage	± (0.02 % R + 0.01 Ω) no visible damage ± (0.25 % R + 0.05 Ω) no visible damage	± (0.05 % R + 0.01 Ω) no visible damage ± (0.25 % R + 0.05 Ω) no visible damage
9.11	6 (Fc)	Vibration	10 sweep cycles per direction; 10 Hz to 2000 Hz 1.5 mm or 200 m/s^2	± (0.01 % R + 0.01 Ω)	± (0.02 % R + 0.01 Ω)	± (0.05 % R + 0.01 Ω)

TEST PROCEDURES AND REQUIREMENTS

IEC 60115-1 CLAUSE (3)	IEC 60068-2 TEST METHOD (3)	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR max.)		
			Stability for product types:	STABILITY CLASS 0.05	STABILITY CLASS 0.1	STABILITY CLASS 0.25
			MBA/SMA 0204	100 Ω to 100 kΩ	43 Ω to 221 kΩ	22 Ω to 332 kΩ
			MBB/SMA 0207	100 Ω to 270 kΩ	43 Ω to 510 kΩ	10 Ω to 1 MΩ
			MBE/SMA 0414	100 Ω to 470 kΩ	43 Ω to 1 MΩ	22 Ω to 1.5 MΩ
10.3		Climatic sequence:				
10.3.4.2	2 (Bb)	Dry heat	125 °C; 16 h			
10.3.4.3	30 (Db)	Damp heat, cyclic	55 °C; 24 h; 90 % to 100 % RH; 1 cycle	± (0.05 % R + 0.01 Ω) no visible damage	± (0.1 % R + 0.01 Ω) no visible damage	± (0.25 % R + 0.05 Ω) no visible damage
10.3.4.4	1 (Ab)	Cold	-55 °C; 2 h			
10.3.4.5	13 (M)	Low air pressure	8.5 kPa; 2 h; 15 °C to 35 °C			
10.3.4.6	30 (Db)	Damp heat, cyclic	55 °C; 5 days; 95 % to 100 % RH; 5 cycles			
10.3.4.7		DC load	Apply rated power for 1 min			
10.4	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; 56 days; (93 ± 3) % RH	± (0.05 % R + 0.01 Ω)	± (0.1 % R + 0.01 Ω)	± (0.25 % R + 0.05 Ω)
7.1	-	Endurance at 70 °C: Precision operation mode	$U = \sqrt{P_{70} \times R}$ or $U = U_{max.}$; 1.5 h on; 0.5 h off			
			70 °C; 1000 h	± (0.05 % R + 0.01 Ω) (1)	± (0.1 % R + 0.01 Ω)	-
			70 °C; 8000 h	± (0.1 % R + 0.01 Ω)	± (0.2 % R + 0.01 Ω)	-
	-	Endurance at 70 °C: Standard operation mode	$U = \sqrt{P_{70} \times R}$ or $U = U_{max.}$; 1.5 h on; 0.5 h off			
			70 °C; 1000 h	-	-	± (0.25 % R + 0.05 Ω) (2)
			70 °C; 8000 h	-	-	± (0.5 % R + 0.05 Ω)
7.3	-	Endurance at upper category temperature	85 °C; 1000 h	-	-	-
			125 °C; 1000 h	± (0.05 % R + 0.01 Ω)	± (0.1 % R + 0.01 Ω)	± (0.25 % R + 0.05 Ω)
11.3	45 (XA)	Component solvent resistance	Isopropyl alcohol +23 °C or +50 °C; toothbrush method	Marking legible; No visible damage		
8.5	-	Electrostatic discharge (human body model)	IEC 61340-3-1; 3 pos. + 3 neg. MBA/SMA 0204: 2 kV MBB/SMA 0207: 4 kV MBE/SMA 0414: 6 kV	± (0.5 % R + 0.05 Ω)		

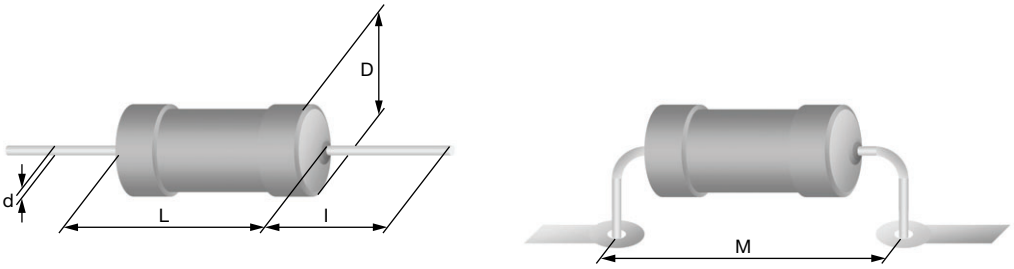
Notes

(1) ± (0.03 % R + 0.01 Ω) for MBB/SMA 0207

(2) ± (0.15 % R + 0.05 Ω) for MBB/SMA 0207

(3) The quoted IEC standards are also released as EN standards with the same number and identical contents

DIMENSIONS



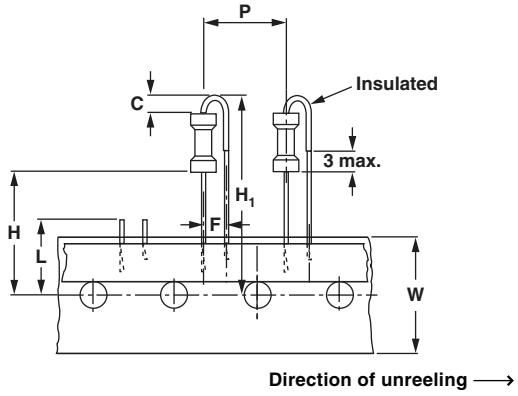
DIMENSIONS - Leaded resistor types, mass and relevant physical dimensions						
TYPE / SIZE	$D_{max.}$ (mm)	$L_{max.}$ (mm)	$d_{nom.}$ (mm)	$l_{min.}$ (mm)	$M_{min.}$ (mm)	MASS (mg)
MBA/SMA 0204	1.6	3.6	0.5	29.0	5.0	125
MBB/SMA 0207 (1)	2.5	6.5	0.6	28.0	10.0 (1)	220
MBE/SMA 0414	4.2	11.9	0.8	31.0	15.0	700

Note

(1) For 7.5 ≤ M < 10.0 mm, use version MBB/SMA 0207... L0 (welding joint not lacquered)

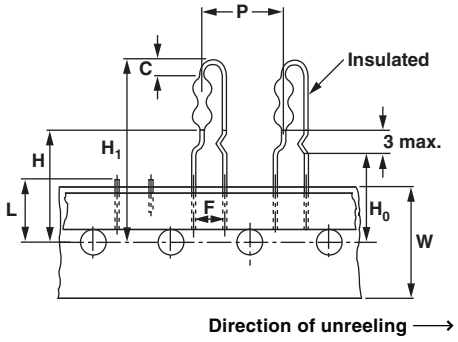
MBB/SMA 0207 WITH RADIAL TAPING

LEAD SPACING (UB = 2.5 mm), SIZE 0207



DIMENSIONS in millimeters		
Pitch of components	P	12.7 ± 1.0
Lead spacing	F	2.5 + 0.6 / - 0.1
Width of carrier tape	W	18.0 + 1.0 / - 0.5
Body to hole center	H	18.0 ± 2.0
Height for cutting (max.)	L	11
Height for bending	C	2.5 + 0 / - 0.5
Height for insertion (max.)	H1	32

LEAD SPACING (RB = 5.0 mm), SIZE 0207



DIMENSIONS in millimeters		
Pitch of components	P	12.7 ± 1.0
Lead spacing	F	5.0 + 0.6 / - 0.1
Width of carrier tape	W	18.0 + 1.0 / - 0.5
Body to hole center	H	18.0 ± 2.0
Lead crimp to hole center	H_0	16.0 ± 0.5
Height for cutting (max.)	L	11
Height for bending	C	2.5 + 0 / - 0.5
Height for insertion (max.)	H_1	32

HISTORICAL 12NC INFORMATION

- The resistors had a 12-digit numeric code starting with 2312
- The subsequent 4 digits indicated the resistor type, specification and packaging; see the 12NC table
- The remaining 4 digits indicated the resistance value:
  - The first 3 digits indicated the resistance value
  - The last digit indicated the resistance decade in accordance with resistance decade table shown below

Resistance Decade

RESISTANCE DECADE	LAST DIGIT
10 Ω to 99.9 Ω	9
100 Ω to 999 Ω	1
1 kΩ to 9.99 kΩ	2
10 kΩ to 99.9 kΩ	3
100 kΩ to 999 kΩ	4
1 MΩ to 9.99 MΩ	5

Historical 12NC Example

The 12NC code of a MBA 0204 resistor, value 47 kΩ and TCR 25 with ± 0.1 % tolerance, supplied on bandolier in a box of 5000 units was: 2312 906 74703.

HISTORICAL 12NC - Resistor type and packaging

DESCRIPTION			2312 ... . (BANDOLIER)				
			AMMOPACK		REEL		
TYPE	TCR	TOL.	C1 1000 UNITS	CT 5000 UNITS	R1 1000 UNITS	R2 2500 UNITS	RP 5000 UNITS
MBA 0204	± 25 ppm/K	± 0.25 %	901 6....	906 6....	701 6....	-	806 6....
		± 0.1 %	901 7....	906 7....	701 7....	-	806 7....
	± 15 ppm/K	± 0.25 %	902 6....	907 6....	702 6....	-	807 6....
		± 0.1 %	902 7....	907 7....	702 7....	-	807 7....
MBB 0207	± 25 ppm/K	± 0.25 %	911 6....	916 6....	711 6....	-	816 6....
		± 0.1 %	911 7....	916 7....	711 7....	-	816 7....
	± 15 ppm/K	± 0.25 %	912 6....	917 6....	712 6....	-	817 6....
		± 0.1 %	912 7....	917 7....	712 7....	-	817 7....
MBE 0414	± 25 ppm/K	± 0.25 %	921 6....	-	-	826 6....	-
		± 0.1 %	921 7....	-	-	826 7....	-
	± 15 ppm/K	± 0.25 %	922 6....	-	-	827 6....	-
		± 0.1 %	922 7....	-	-	827 7....	-

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, “Vishay”), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.